# CRMETL0303A

#### N-Channel 30V, 2.2mΩ Typ. Power MOSFET

## **Description**

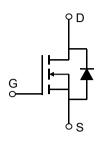
#### **Features**

• 30V, 150A

$$R_{DS(ON)}$$
 Typ = 2.2m $\Omega$  @  $V_{GS}$  = 10 $V$ 

$$R_{DS(ON)}$$
 Typ = 3.3m $\Omega$  @  $V_{GS}$  = 4.5 $V$ 

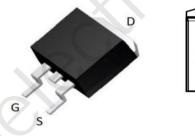
- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

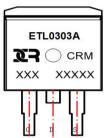




# **Application**

- Load Switch
- PWM Application
- Power Management





**Marking and Pin Assignment** 

## **Package Marking and Ordering Information**

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMETL0303A	CRMETL0303A	TO-263-3L	TAPING	13"	800	4000

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		30	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T <sub>C</sub> = 25°C	150	А
I <sub>D</sub>		T <sub>C</sub> = 100°C	90	Α
I <sub>DM</sub>	Pulsed Drain Current (1)		600	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (2)		210	mJ
$P_{D}$	Power Dissipation	T <sub>C</sub> = 25°C	125	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		1	°C/W
$T_J,T_STG$	Junction & Storage Temperature Range		-55 to 150	°C

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# **Electrical Characteristics** ( $T_J = 25$ °C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
$I_{GSS}$	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics					
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.6	2.2	V
D	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 10V, I_D = 20A$	-	2.2	2.9	mΩ
$R_{DS(ON)}$		$V_{GS} = 4.5V, I_D = 10A$	-	3.3	4.3	mΩ
Dynamic	Characteristics					
$C_{iss}$	Input Capacitance		-	3800	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	<b>X</b> -	441	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	329	-	pF
$Q_g$	Total Gate Charge	V 01 10V	<b>)</b> -	67	-	nC
$Q_gs$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_{D} = 15A$	-	11	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> TOV, I <sub>D</sub> TOV	-	19	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime		-	10	-	ns
$t_r$	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	19	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 30A$ , $R_{GEN} = 3\Omega$	-	50	-	ns
$t_{f}$	Turn-Off Fall Time		-	20	-	ns
Drain-So	urce Diode Characteristics and M	ax Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	150	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode F	Forward Current	-	-	600	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	L = 200 dildt = 4000/	-	18	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 20A$ , di/dt = 100A/us	-	6	-	nC

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $E_{AS}$  condition: Starting  $T_J$ =25°C,  $V_{DD}$ =15V,  $V_G$ =10V,  $R_G$ =25ohm, L=0.5mH,  $I_{AS}$ =29A

<sup>3.</sup> Pulse Test: Pulse Width  $\!\! \leq \! \! 300 \mu s,$  Duty Cycle  $\! \leq \! 0.5 \%.$ 

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## **Test Circuit**

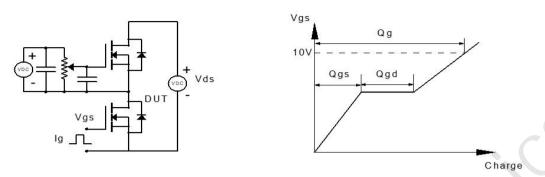


Figure 1: Gate Charge Test Circuit & Waveform

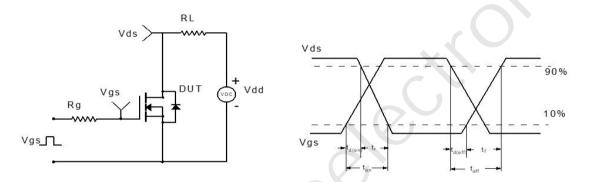


Figure 2: Resistive Switching Test Circuit & Waveform

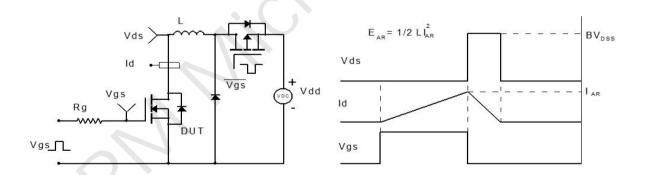


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

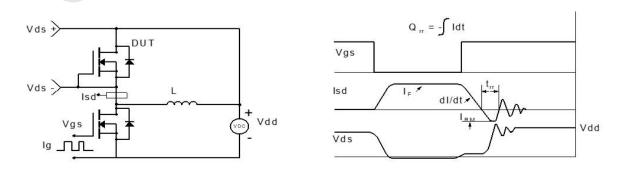
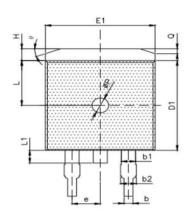


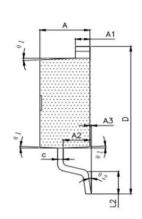
Figure 4: Diode Recovery Test Circuit & Waveform

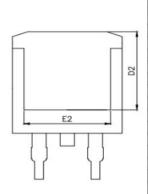
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## Package Mechanical Data(TO-263-3L)







SYMBOL	MILLIMETER				
	MIN	NOM	MAX		
A	4.40	4.50	4.60		
A1	1.20	1.30	1.40		
A2	2.30	2.40	2.50		
A3	0.03	0.13	0.23		
b	0.70	0.80	0.90		
b1	1.21	1.27	1.40		
b2	1.25	1.35	1.45		
С	0.40	0.50	0.60		
D	14.80	15.10	15.40		
D1	9.10	9.20	9.30		
D2	8.00				
E	9.70	9.90	10.20		
E1	9.68	9.88	10.08		
E2	7.80				
е	2.54 (BSC)				
н	1.00	1.20	1.40		
L	4.30	4.60	4.90		
L1	1.10	1.30	1.50		
L2	2.10	2.30	2.50		
ØΡ	1.40	1.50	1.60		
Q	0.50 (REF)				
θ	16"	20° 24			
91	1*	3*	5*		
θ2	0.	-	9,		

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